

Mechanics for the beam pipe , FFD and ITS integration with TPC

Yuri Murin on behalf of the NICA MPD ITS Consortium

XIV MPD Collaboration Meeting, Dubna October 14, 2024

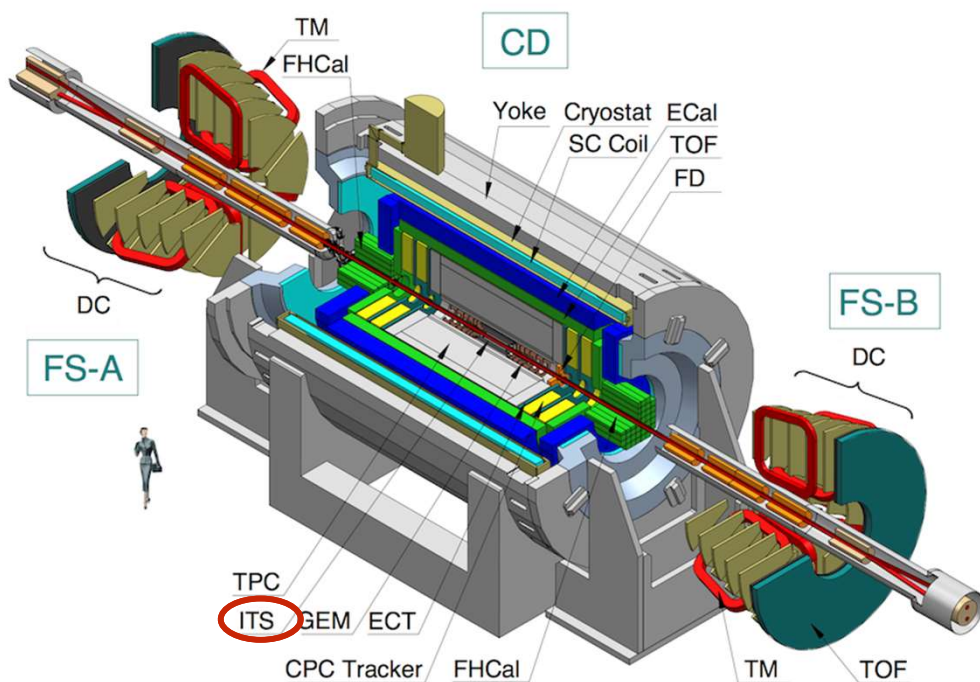


XIV-th MPD Collaboration Meeting, Dubna 14.10.2024

- ❑ MPD ITS Consortium introduction
- ❑ Igolkin's idea of integration with Installation Container
- ❑ The MPD Installation Container status and perspectives
- ❑ Timelines of milestones and deliverables
- ❑ Activity beyond IC:
 - 1) Design, production and thermocycle tests of the wire-target unit
 - 2) Computer simulations to estimate the “price” of compromises on BP

MPD-ITS structure: 3-layers Inner Barrel + 3-layers Outer Barrel .

It will supplement the TPC for the precise tracking, momentum determination and vertex reconstruction for **low Pt momenta hyperons** (Λ , Ξ , Ω) and identification of **D-mesons**.



Some of the MPD-ITS requirements:

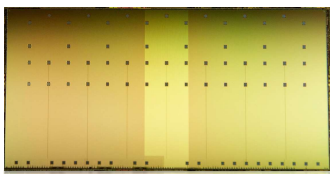
- Fast, high granularity CMOS pixel sensors with low noise level.
- Spatial resolution of track coordinate registration at the level of $\sim 5-10 \mu\text{m}$.
- Material budget as low as possible.
- Positioned as close as possible to the interaction diamond

Yu. A. Murin and C. Ceballos, "The Inner Tracking System for the MPD Setup of the NICA Collider", Phys. Part. Nuclei 52, 742-751 (2021).

The MAPS chip - ALPIDE

- » High-resistivity ($> 1\text{k}\Omega\text{ cm}$) p-type epitaxial layer ($20\mu\text{m} - 40\mu\text{m}$ thick) on p-type substrate.
- » Small n-well diode ($2-3\ \mu\text{m}$ diameter), ~ 100 times smaller than pixel \Rightarrow low capacitance.
- » Deep PWELL shields NWELL of PMOS transistors, allowing for full CMOS circuitry within active area.
- » Global shutter readout pixels' matrix

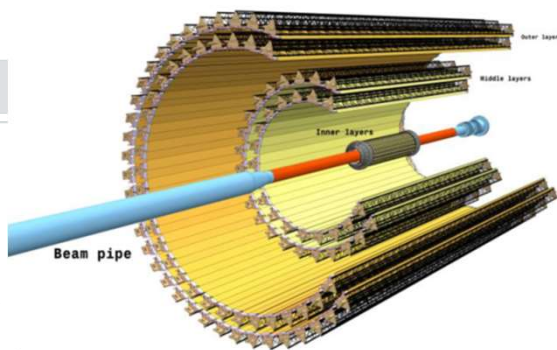
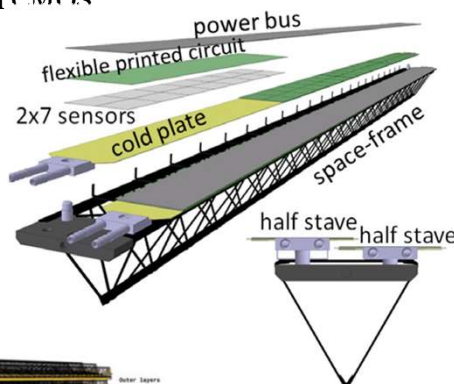
512 x 1024 pixels



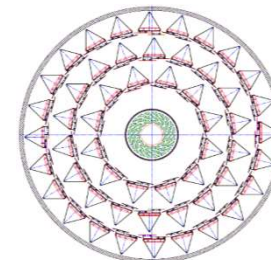
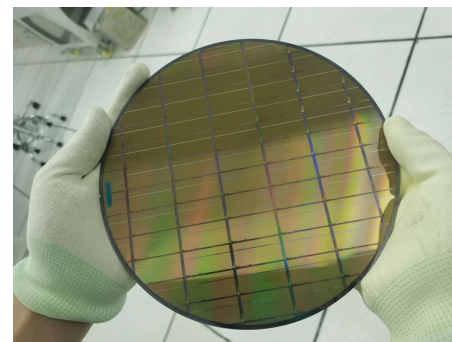
Sensor architecture

Size: $15\text{mm} \times 30\text{mm}$
 Pixel pitch: $28\mu\text{m} \times 28\mu\text{m}$
 Event time resolution: $< 2\mu\text{s}$
 Power consumption: $39\text{mW}/\text{cm}^2$
 Dead area $1.1\text{mm} \times 30\text{mm}$

- 24120 pixel sensors
 - $\sim 12,5$ Gpixels
 - 10 m^2 active area



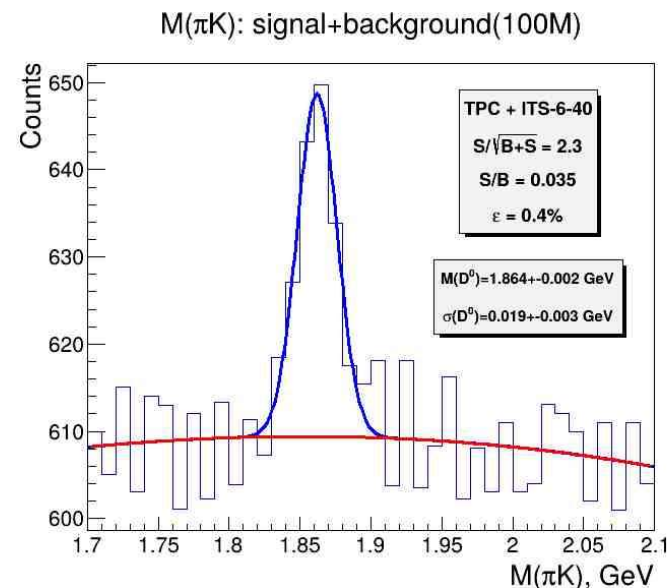
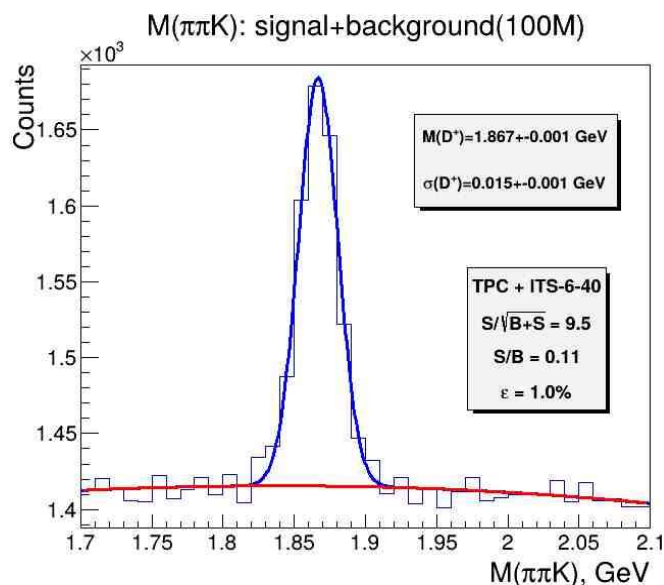
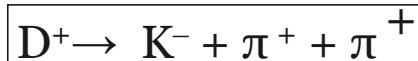
The MAPS chip - MICA



Number of staves
 - IB = $(12+16+20) \times 2$
 OB = $(12+18+24)$

- 11556 pixel sensors
 - $\sim 5,8$ Gpixels
 - 5 m^2 active area

D⁺ and D⁰ reconstruction using KF with TPC-TOF PID



$N_D = 19\,000$ mesons/month for D^+

$N_D = 3\,200$ mesons/month for D^0

Using the optimal BDT cut allows to reconstruct D^+ and D^0 with an efficiency of **1.0%** and **0.4%** respectively.

Particle	D^+	D^0
Efficiency, %	1.0	0.4
Significance	9.5	2.3
S/B(2σ) ratio	0.11	0.035

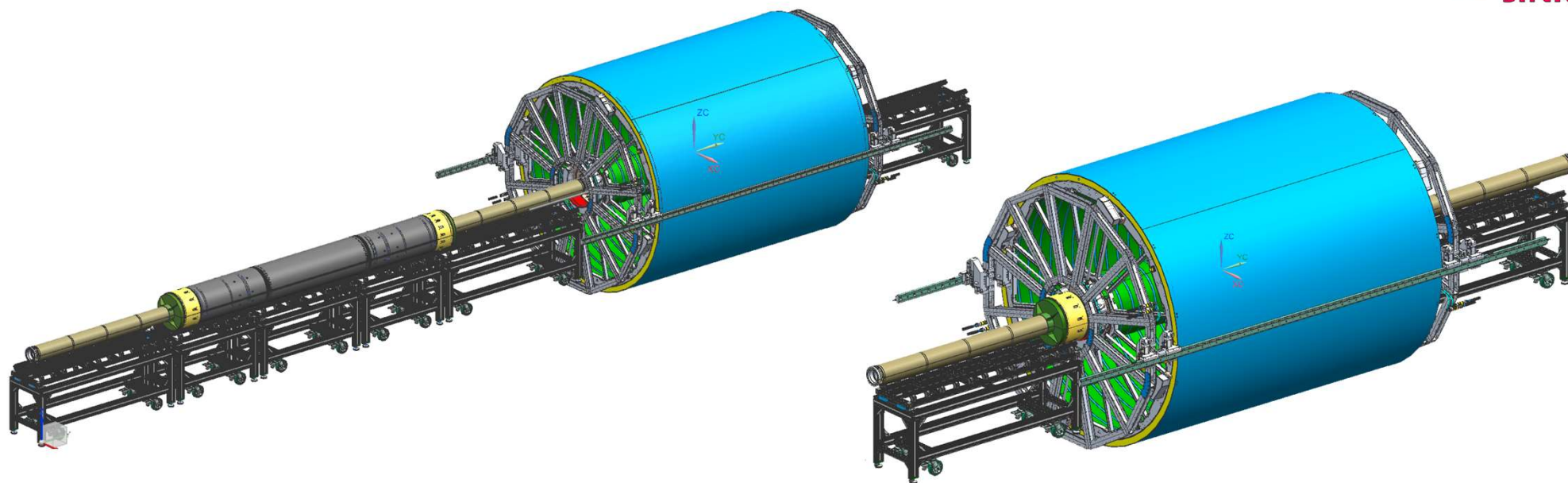
Establish the 'NICA MPD-ITS Consortium'

- **In order to further cooperate between JINR and Chinese institutions, the "NICA MPD-ITS Consortium" has been established:**
 - ◆ The acting time for the consortium is 5 years;
 - ◆ The coordinator center within the Russian Federation will be the JINR and in China will be the CCNU
 - ◆ The other institutions participating in the Consortium will have each one representative on the project structure for decision making and control.





The MPD Installation Container conceptual approach put forward by Sergei Igolkin (SpbSU,SPb)



The 50 cm diameter of the TPC bore is too narrow to do otherwise !



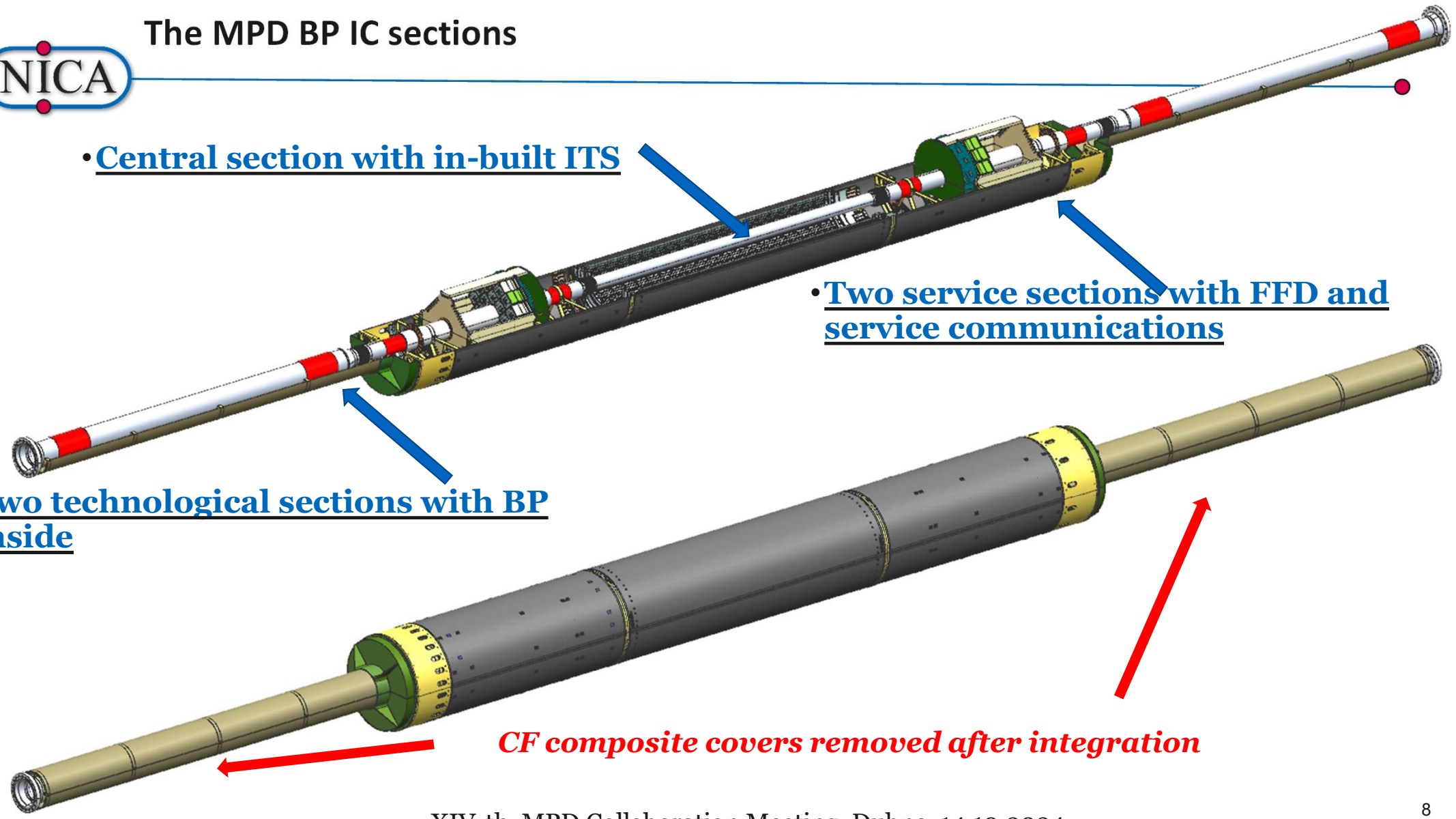
The MPD BP IC sections

• Central section with in-built ITS

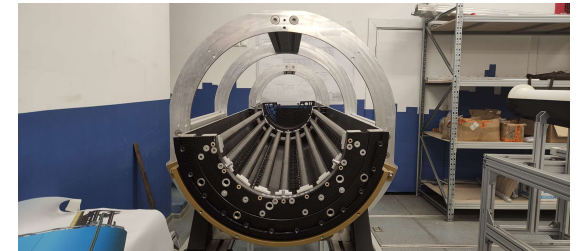
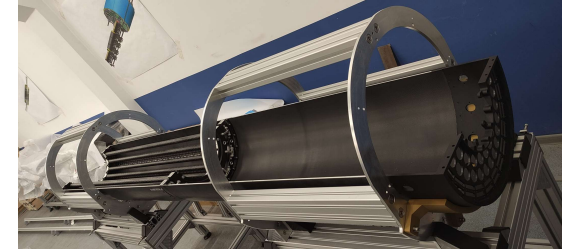
• Two service sections with FFD and service communications

• Two technological sections with BP inside

CF composite covers removed after integration



Current status: 95% IC readiness for dry tests of the integration scenario



- Designed & produced in the house by D.Andreev +3
- GrafitPro (Moscow) cage manufacturing



The yet-to-do list with timelines of major milestones

In the Lab (now – 27.12.2024)

- **Design and production of BP fixtures for mounting and fixation BP inside IC**
- **Finalization of production of the support wheels for first additional layer of the ITS OB**
- **Design and production of the Interceptor**
- **Design and production of wire-target unit (together with AD)**

In the MPD Hall (10.01.2025 – 27.06.2025)

- **Dry test of the installation scenario with TPC dummy at different incline angles**
- **Design and production of auxiliary fixtures and tooling**



Last but not least:

Computer simulations for estimation the impact of the beam pipe properties on expected momenta resolution and tracking efficiency in “TPC only” and “TPC+ITS(OB)” configurations and FXT mode

- **Beam pipe:** Stainless steel (80 mm); Ti (64 mm), Al(64 mm); Be(64 mm)
- **Projectile nuclei:** 2.5AGeV Xe; 2.5AGeV Bi
- **Targets:** Be(50 um), Au(50um;2x25 um); W(?um)
- **Result:** relative transverse and full momenta resolution and tracking efficiency as function of momenta for identified secondaries; wires and beampipe images, etc.

Target R&D

- **Production and thermocycle tests of few wire-targets carriers with mounted wires (anticipated materials Be, Au and W; anticipated method: US bonding or UHV compatible adhesive)**



Credits and Thanks – to persons involved in mechanics in red



Murin Yuri
 Cesar Ceballos
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 Reyes Solne
 Herera Maribel
 Gaganova Maria
 Peres Margarita
 Udovenko Svetlana
 Leontiev Vladimir
 Sheremetiev Aleksei
 Andreeva Tatiana
 Semchukova Tatiana
 Elisha Vladimir
Andreev Denis
Voronin Aleksei
 Kolojvari Anatoly
 Patronova Svetlana
 Igor Rufanov
Panfilov Andrey



Zherebchevsky Vladimir
Igolkin Sregey
 Kondratiev Valery



孙向明 [Sun Xiangming] (CCNU)
 小乐 [Xiao Le] (CCNU)
 王亚平 [Wang Yaping] (CCNU)
 赵磊 [Zhao Lei] (USTC)
 陆云鹏 [Lu Yunpeng] (IHEP)
 赵晨新 [Zhao Chenxin] (IMP)
 郭迪 [Guo Di] (CCNU)
 高超松 [Gao Chaosong] (CCNU)
 钱家俊 [Qin Jiajun] (USTC)
 周扬 [Zhou Yang] (IHEP)



Musa Luciano
 Di Mauro Antonello

**Industrial partners : GrafitPro(Moscow),
 MELZ (Zaprudnia),
 Mezon Ltd(SPb)**

Thanks for your attention!

